FOR IMMEDIATE RELEASE

Lasertec Corporation
2-10-1 Shin-yokohama, Kohoku-ku, Yokohama
(Tokyo Stock Exchange Prime Market, Code 6920)

Announcement Regarding the Decision to Enter into Commitment Line Agreements

Yokohama, November 25, 2024 - Lasertec Corporation hereby announces that the Board of Directors resolved today on the company's decision to enter into commitment line agreements as follows.

1. Reason for the company's decision to enter into commitment line agreements

The company currently has a commitment line agreement for loans up to the total amount of 40 billion yen in place, which it entered into as announced in "Announcement Regarding the Decision to Enter into a Commitment Line Agreement" dated November 29, 2021. Since this agreement is due to expire at the end of December 2024, the Board has resolved that the company enters into new commitment line agreements with the same total amount as described below to continue to have a means of financing its operating capital necessary for further business growth, thereby maintaining a stable and flexible financial operation and sound management.

2. Summary of the commitment line agreements

Financial Institution	MUFG Bank, Ltd.	Sumitomo Mitsui Banking Corporation
Commitment Amount	20 billion JPY	20 billion JPY
Effective Date	End of December 2024 (Planned)	End of December 2024 (Planned)
Agreement Type	Bilateral	Bilateral
Agreement Period	Three years	Five years
Collateral and Guarantee	No collateral, no guarantee	No collateral, no guarantee

3. Future Outlook

There will be no revisions to our full-year forecast as a result of these commitment line agreements. If there arises a situation where a public announcement should be made, we will promptly make an announcement.

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